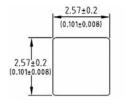
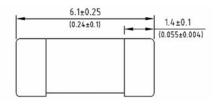
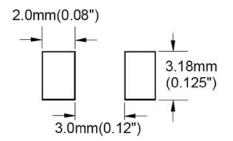
Dimensions - mm

Drawing Not to Scale

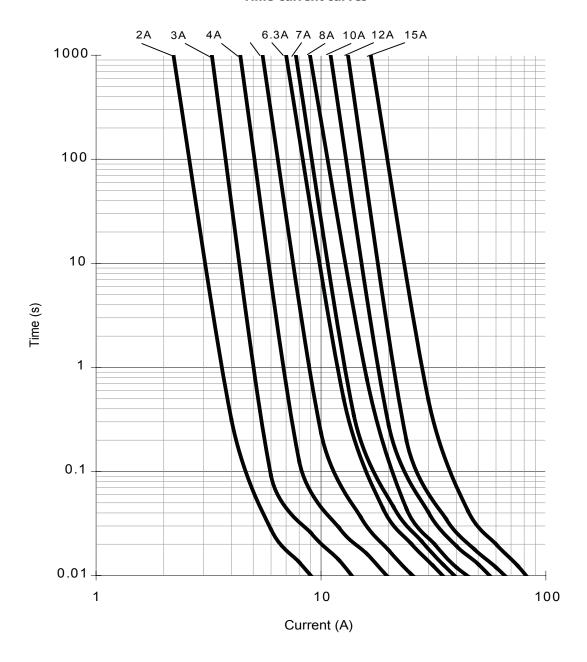




Recommended pad layout



Time-current curves



Soldering Characteristics

Wave Immersion

• Reservoir Temperature: +260 °C

• Time in Reservoir: 10 seconds maximum

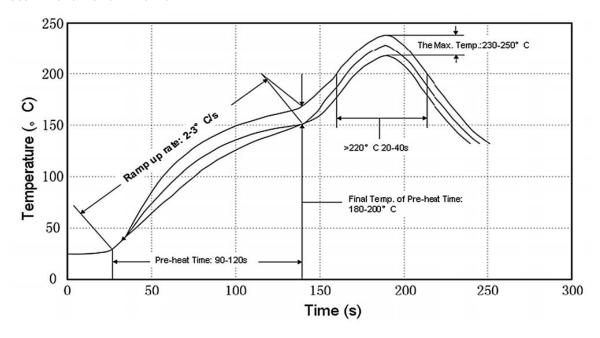
Infrared Reflow

Temperature: +260 °CTime: 30 seconds maximum

Hand Soldering

Maximum tip temperature: +350 °C
Maximum soldering time: 5 seconds max

Recommend Reflow Profile



Packaging Code	
Packaging Code Suffix	Description
-TR1	1000 Fuses in Tape and Reel on 7 inch (178mm) diameter reel
-TR2	5000 Fuses in Tape and Reel on 13 inch (330mm) diameter reel

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

Eaton

Electronics Division 1000 Eaton Boulevard

Cleveland, OH 44122 United States Eaton.com/electronics



© 2020 Eaton All Rights Reserved Printed in USA Publication No. 4377 July 2020

Eaton is a registered trademark.

All other trademarks are property of their respective owners.

Follow us on social media to get the latest product and support information









